| © Copyright                                       | l Composition De<br>ht 2005. IPC, Bannockl<br>al and Pan-American co | ourn, Illinois. A             | Il rights reserved untions. | under both              | This docume<br>level parts, t | ent is a declar<br>he declaration | ation of t<br>n encomp                    | the substances<br>basses all low | s within the manufactu<br>er level materials for v | rer listed i<br>which the n            | tem. Note: i<br>nanufacture | if the item is an as<br>r has engineering | sembly with lower responsibility. |
|---|--|-------------------------------|-----------------------------|-------------------------|-------------------------------|-----------------------------------|---|----------------------------------|--|--|-----------------------------|---|-----------------------------------|
|   |  |                               |                             | Form Type<br>Distribute |                               |                                   |   |                                  |  | ials and Mfg Information               |                             |   |                                   |
| Supplier Information                              |  |                               |                             |                         |                               |                                   |   |                                  |  |  |                             |   |                                   |
| Company name*                                     | Company un   | Company unique ID             |                             |                         | Unique ID Authority           |                                   |   |                                  |  | Response Date*                         |                             |   |                                   |
| onsemi  |  |                               |                             |                         |                               |                                   |   |                                  | 2025-05  | 2025-05-13                             |                             |   |                                   |
| Contact Name                                      | Title - Conta  | Title - Contact               |                             |                         | Phone - Contact*              |                                   |   |                                  |  | Email - Contact*                       |                             |   |                                   |
| Product-Env-Stewards                              | Product Envi   | Product Enviro Compliance     |                             |                         | NA                            |                                   |   |                                  | Produc   | Product-Env-Stewards@onsemi.com        |                             |   |                                   |
| Authorized Representative* Tit                    |  |                               | Title - Representative      |                         |                               | Phone - Representative*           |   |                                  | Email -  | Email - Representative*                |                             |   |                                   |
| Product-Env-Stewards                              | Product Enviro Compliance  |                               |                             | NA                      |                               |                                   |   | Produc                           | Product-Env-Stewards@onsemi.com                    |  |                             |   |                                   |
| Requester Item Numbe                              | Requester Item Number Mfr Item                                       |                               | Number Mfr Item Name        |                         |                               | Effective Da                      | te Vers                                   | sion                             | Manufacturing Site                                 |  | Weight*                     | UOM                                       | Unit Type                         |
|   | NCS200   | CS20071SN2T1G R2R Output Sing |                             | le 3 MHz Op Ai          | mp                            | 2025-05-13                        |   |                                  | MY1  |  | 14.08                       | mg  | Each                              |
| Manufacturing Proccess I                          | nformation   |                               |                             |                         |                               |                                   |   |                                  |  | ·                                      |                             |   |                                   |
| Terminal Plating / Grid Array Material Terminal B |  | erminal Base                  | Alloy J-STD-020 MSL Rati    |                         | L Rating                      | Peak Pr                           | Peak Process Body Temperature Max Time at |                                  | are Max Time at Peak                               | ak Temperature Number of Reflow Cycles |                             |   | les                               |
| Matte Tin (Sn) - annealed CU Alloy                |  |                               |                             | 1                       |                               | 260                               |   | С                                | 30   | secon                                  | ds 3                        |   |                                   |
| Comments  |  |                               |                             |                         |                               |                                   |   |                                  |  |  |                             |   |                                   |
| level 1 - maximum time at peak to                 | emperature during so   | dering is 10-3                | 0 seconds                   |                         |                               |                                   |   |                                  |  |  |                             |   |                                   |
| For more information regarding                    | material composition   | please refer to               | page 3                      |                         |                               |                                   |   |                                  |  |  |                             |   |                                   |

| RoHS Material Composition Declaration  |   |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |
|--|---|--|---|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the  | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and co<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa   | on above   | Supplier Acceptance   | * Accepted                                      |   |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per  | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU  |  |   |   |   |  |  |  |  |  |  |
| Declaration Signature  |   |  |   |   |   |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester   | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska   | Le   |   |   |   |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Iomogeneous Material Weight Unit of Me |      | Unit of Measure | Level    | Substance  | CAS              | Exempt | Weight | Unit of Measure |
|--|------|-----------------|----------|--|------------------|--------|--------|-----------------|
| Die                                    | 0.42 | mg              | Supplier | Silicon (Si)   | 7440-21-3        |        | 0.42   | mg              |
| Die Attach                             | 0.11 | mg              |          | Epoxy resin  | proprietary data |        | 0.033  | mg              |
|  |      |                 | Supplier | Fatty acids, C18-unsatd., dimers, polymers with epichlorhydrin         | 68475-94-5       |        | 0.033  | mg              |
|  |      |                 | Supplier | 2,2'-[[2-(oxiranylmethoxy)-1,3-<br>phenylene]bis(methylene)]bisoxirane | 13561-08-5       |        | 0.033  | mg              |
|  |      |                 | Supplier | 4-Methyl-2-Phenyl-1H-Imidazole   | 827-43-0         |        | 0.0099 | mg              |
|  |      |                 | Supplier | Phenolic Resin (Novolac)   | 9003-35-4        |        | 0.0011 | mg              |
| Lead Frame                             | 5.78 | mg              | Supplier | Silver (Ag)  | 7440-22-4        |        | 0.0705 | mg              |
|  |      |                 | Supplier | Zinc (Zn)  | 7440-66-6        |        | 0.0069 | mg              |
|  |      |                 | Supplier | Iron (Fe)  | 7439-89-6        |        | 0.1358 | mg              |
|  |      |                 | Supplier | Copper (Cu)  | 7440-50-8        |        | 5.565  | mg              |
|  |      |                 | Supplier | Phosphorus (P)   | 7723-14-0        |        | 0.0017 | mg              |
| Mold Compound-Black                    | 7.34 | mg              |          | Epoxy resin  | proprietary data |        | 0.367  | mg              |
|  |      |                 | Supplier | Phenolic Resin   | Proprietary Data |        | 0.367  | mg              |
|  |      |                 | Supplier | Ortho Cresol Novolac Resin   | 29690-82-2       |        | 0.1468 | mg              |
|  |      |                 | Supplier | Carbon Black (C)   | 1333-86-4        |        | 0.0367 | mg              |
|  |      |                 | Supplier | Fused Silica (SiO2)  | 60676-86-0       |        | 6.4225 | mg              |
| lating                                 | 0.39 | mg              | Supplier | Tin (Sn)   | 7440-31-5        |        | 0.39   | mg              |
| Wire Bond - Au                         | 0.04 | mg              | Supplier | Gold (Au)  | 7440-57-5        |        | 0.04   | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).